ASSOCIATION CONNECTING	© Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved utions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufactule level materials for w	urer listed which the	item. Note: nanufacture	if the item is an as er has engineering	ssembly with low responsibility.	
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					Ifg Informa	ation			
Supplier Informa	ation														
Company name*			Company unique ID			Unique ID Authority				Respon	Response Date*				
nsemi											2023-00	2023-06-08			
Contact Name Tit			Title - Contac	Title - Contact			Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* T			Title - Representative			Phone - Representative*				Email -	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Requester	Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Date	te Version Manufacturing Site			Weight*	UOM	Unit Type		
		NCV4274CDS33R4G 3.3V/400		3.3V/400mA LD	3V/400mA LDO		2023-06-08		M	MY1		1114.83	mg	Each	
Ianufacturing F	Proccess Information	1						-							
Terminal Plating / Grid Array Material Terminal Base			Alloy	Peak Process Body Temperature Max Time at Peak T				k Tempera	Temperature Number of Reflow Cycles						
Matte Tin (Sn) - annealed CU			CU Alloy	loy 1			260 C 30			seco	seconds 3				
omments															
vel 1 - maximum tii	me at peak temperature o	luring sol	dering is 10-3	0 seconds											
or more information	n regarding material con	position	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter [F] Optionally enter the positive (+) ar				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.43	mg	Supplier	Silicon (Si)	7440-21-3		2.43	mg
Die Attach	3.66	mg	А	Lead (Pb)	7439-92-1	7a	3.477	mg
			Supplier	Tin (Sn)	7440-31-5		0.183	mg
Lead Frame	341.85	mg	В	Nickel (Ni)	7440-02-0		1.0256	mg
			Supplier	Copper (Cu)	7440-50-8		340.8245	mg
Mold Compound-Black	739.4	mg		Epoxy Phenol Resin	proprietary data		77.637	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		661.763	mg
Plating	27.15	mg	Supplier	Tin (Sn)	7440-31-5		27.15	mg
Wire Bond - Cu	0.34	mg	Supplier	Copper (Cu)	7440-50-8		0.34	mg